

Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
16V	3.7mΩ@4.5V	18A
	3.8mΩ@4.0V	
	3.9mΩ@3.8V	
	4.2mΩ@3.1V	
	4.7mΩ@2.5V	

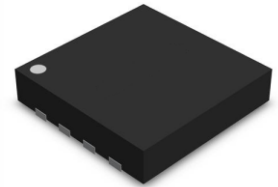
Feature

- Trench Power MOSFET
- Excellent $R_{DS(on)}$
- Low Gate Charge
- ESD Protected

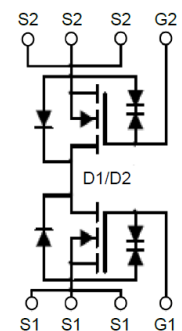
Application

- Load Switch
- Battery Switch

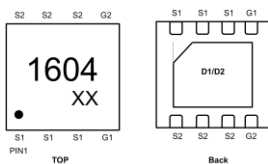
DFN3×3-8L



Schematic diagram



MARKING:



ABSOLUTE MAXIMUM RATINGS ($T_a=25^{\circ}\text{C}$ unless otherwise noted)

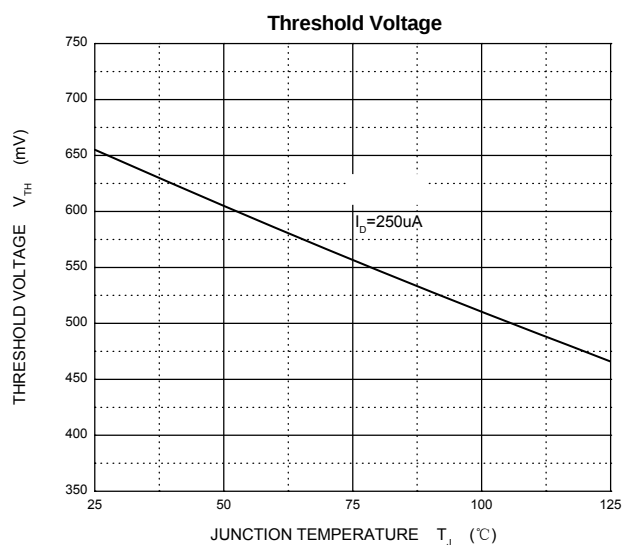
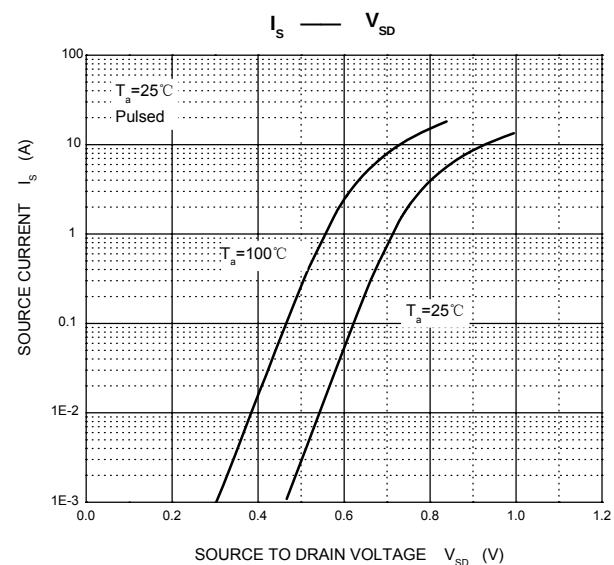
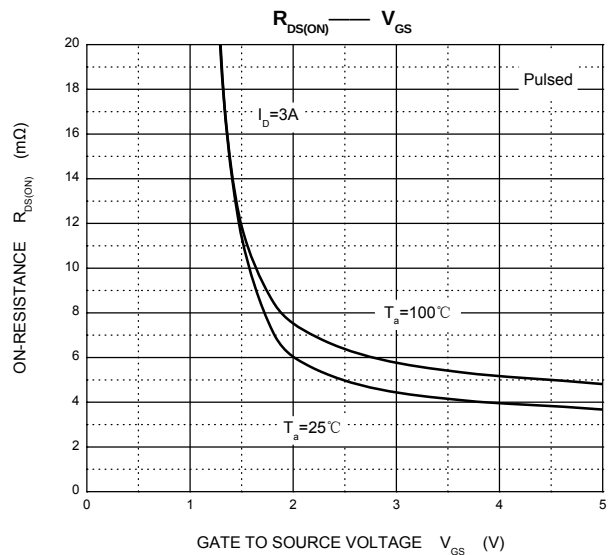
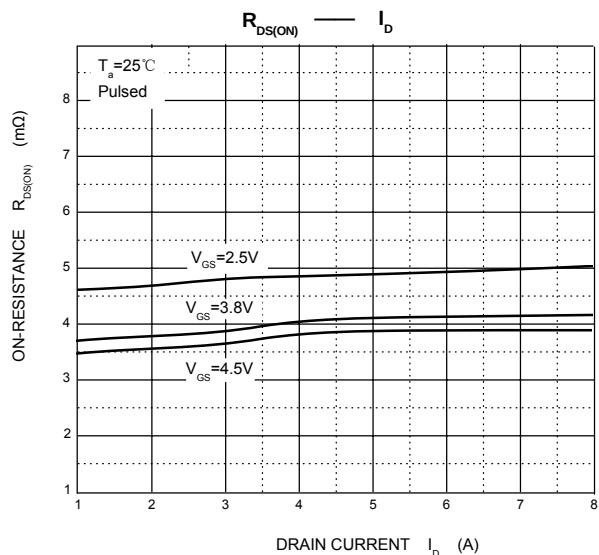
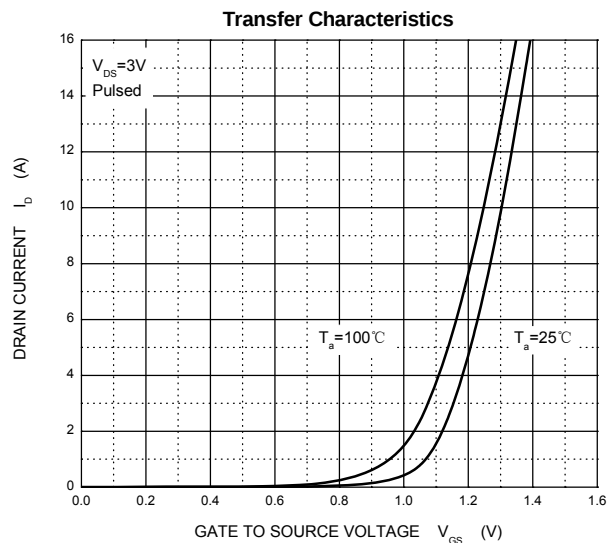
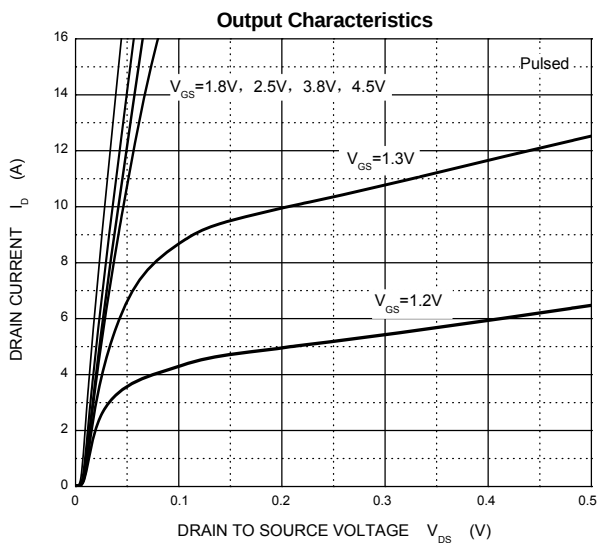
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	16	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current ^{1,2}	I_D	18	A
Pulsed Drain Current	I_{DM}	72	A
Power Dissipation	P_D	3	W
Thermal Resistance from Junction to Ambient ^{1,2}	$R_{\theta JA}$	42	$^{\circ}\text{C/W}$
Total Power Dissipation	P_D	3	W
Junction Temperature	T_J	150	$^{\circ}\text{C}$
Storage Temperature	T_{STG}	-55~ +150	

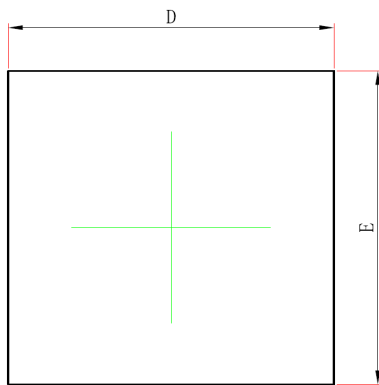
MOSFET ELECTRICAL CHARACTERISTICS($T_a=25^{\circ}\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Off Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	16			V
Zero gate voltage drain current	I _{DSS}	V _{DS} = 16V, V _{GS} = 0V			1	μA
Gate-body leakage current	I _{GSS}	V _{GS} = ±4.5V, V _{DS} = 0V			±1	μA
		V _{GS} = ±8V, V _{DS} = 0V			±5	μA
On Characteristics						
Gate threshold voltage ³	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	0.4	0.65	1	V
Drain-source on-resistance ³	R _{DS(on)}	V _{GS} = 4.5V, I _D = 3A	2.7	3.7	4.7	mΩ
		V _{GS} = 4.0V, I _D = 3A	2.8	3.8	4.8	
		V _{GS} = 3.8V, I _D = 3A	2.9	3.9	4.9	
		V _{GS} = 3.1V, I _D = 3A	3.2	4.2	5.2	
		V _{GS} = 2.5V, I _D = 3A	3.7	4.7	5.9	
Forward tranconductance ³	g _{FS}	V _{DS} = 5V, I _D = 3A	8			S
Dynamic Characteristics						
Input Capacitance	C _{iss}	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz		1950		pF
Output Capacitance	C _{oss}			310		
Reverse Transfer Capacitance	C _{rss}			270		
Switching Characteristics						
Total gate charge	Q _g	V _{DS} = 10V, V _{GS} = 4.5V, I _D = 3A		25		nC
Gate-source charge	Q _{gs}			2.3		
Gate-drain charge	Q _{gd}			7.5		
Turn-on delay time	t _{d(on)}	V _{GS} = 5V, V _{DD} = 10V, I _D = 3A R _L = 1.35Ω, R _{GEN} = 3Ω		4.4		ns
Turn-on rise time	t _r			8.7		
Turn-off delay time	t _{d(off)}			80		
Turn-off fall time	t _f			23		
Drain-Source Diode Characteristics						
Diode forward current	I _S				18	A
Diode forward voltag ³	V _{SD}	I _S = 1A, V _{GS} = 0V			1.2	V

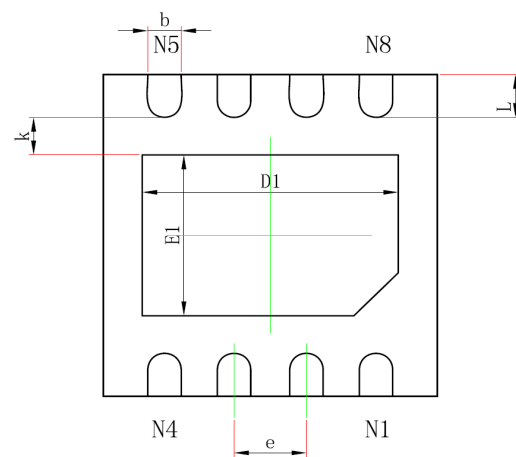
Notes :

1. $R_{\theta JA}$ is measured with the device mounted on 1 in² FR4 board with 1oz. single side copper, in a still air environment with $T_A = 25^{\circ}\text{C}$.
2. $R_{\theta JA}$ is measured in the steady state
3. Pulse test : Pulse width $\leq 380\mu s$, duty cycle $\leq 2\%$.

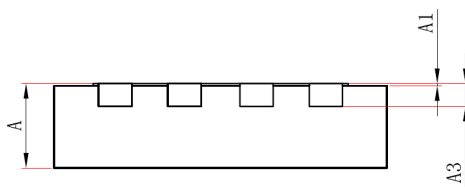
Typical Electrical and Thermal Characteristics


DFN3×3-8L Package Information


TOP VIEW



BOTTOM VIEW



SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	2.924	3.076	0.115	0.121
E	2.924	3.076	0.115	0.121
D1	2.200	2.400	0.087	0.094
E1	1.400	1.600	0.055	0.063
b	0.250	0.350	0.010	0.014
k	0.200MIN		0.008MIN	
e	0.650TYP.		0.026TYP.	
L	0.324	0.476	0.013	0.019